

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
<b>CONVEYING PARTY DATA</b>											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Seong Jae Lim</td> <td>05/12/2010</td> </tr> <tr> <td>Hyon I Kim</td> <td>05/12/2010</td> </tr> <tr> <td>Ji Youn Cha</td> <td>05/12/2010</td> </tr> <tr> <td>Hyun Chul Kim</td> <td>05/12/2010</td> </tr> </tbody> </table>		Name	Execution Date	Seong Jae Lim	05/12/2010	Hyon I Kim	05/12/2010	Ji Youn Cha	05/12/2010	Hyun Chul Kim	05/12/2010
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Seong Jae Lim	05/12/2010										
Hyon I Kim	05/12/2010										
Ji Youn Cha	05/12/2010										
Hyun Chul Kim	05/12/2010										
<b>RECEIVING PARTY DATA</b>											
Name:	LG Electronics Inc.										
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City:	Seoul										
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Postal Code:	150-721										
<b>PROPERTY NUMBERS Total: 1</b>											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12362388</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12362388						
Property Type	Number										
Application Number:	12362388										
<b>CORRESPONDENCE DATA</b>											
Fax Number:	(202)739-3001										
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NAME OF SUBMITTER:	Robert J. Goodell										

CH \$40.00 12362388

Total Attachments: 2  
 source=001082-7009\_Assignment-05252010.pfg#page 1.tif

**501186527**

**PATENT  
 REEL: 024438 FRAME: 0053**



**ASSIGNMENT**

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

**MOBILE PHONE**

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on \_\_\_\_, (Application No. \_\_\_\_); and

WHEREAS, LG ELECTRONICS INC., a corporation of Republic of Korea, whose post office address is 20 Yeouido-dong Yeongdeungpo-gu Seoul 150-721 Republic of Korea, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. \_\_\_\_\_, filed \_\_\_\_\_) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

<b>Full Name of Sole or First Assignor</b> LIM, Seong Jae	Assignor's Signature <i>Lim, Seong Jae</i>	Date May 12, 2010
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Names of additional inventors attached <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No		

<b>Full Name of Third Assignor</b> CHA, Ji Youn	<b>Assignor's Signature</b> <i>Cha, Ji Youn</i>	<b>Date</b> May 12, 2010
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<b>Full Name of Sixth Assignor</b>	<b>Assignor's Signature</b>	<b>Date</b>
Address		<b>Citizenship</b>
<b>Full Name of Seventh Assignor</b>	<b>Assignor's Signature</b>	<b>Date</b>
Address		<b>Citizenship</b>
<b>Full Name of Eighth Assignor</b>	<b>Assignor's Signature</b>	<b>Date</b>
Address		<b>Citizenship</b>
<b>Full Name of Ninth Assignor</b>	<b>Assignor's Signature</b>	<b>Date</b>
Address		<b>Citizenship</b>
<b>Full Name of Tenth Assignor</b>	<b>Assignor's Signature</b>	<b>Date</b>
Address		<b>Citizenship</b>
<b>Full Name of Eleventh Assignor</b>	<b>Assignor's Signature</b>	<b>Date</b>
Address		<b>Citizenship</b>
Names of additional inventors attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		